

# GBU8A - GBU8M Bridge Rectifiers

# Features

- Glass passivated junction
- Surge overload rating: 200 amperes peak
- Reliable low cost construction utilizing molded plastic technique.
- Ideal for printed circuit board.
- UL certified, UL # E326243.

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|-------|--|
| GBU   |  |

September 2011

| Symbol             | Parameter  | Value  |             |     |     |     |     | Units  |       |
|--------------------|--|--------|-------------|-----|-----|-----|-----|--------|-------|
|                    |  | 8A     | 8B          | 8D  | 8G  | 8J  | 8K  | 8M     | Units |
| V <sub>RRM</sub>   | Maximum Repetitive Reverse Voltage   | 50 100 |             | 200 | 400 | 600 | 800 | 1000   | V     |
| V <sub>RMS</sub>   | Maximum RMS Bridge Input Voltage   |        | 70          | 140 | 280 | 420 | 560 | 700    | V     |
| V <sub>R</sub>     | DC Reverse Voltage (Rated V <sub>R</sub> )   |        | 100         | 200 | 400 | 600 | 800 | 1000   | V     |
| I <sub>F(AV)</sub> | Average Recitified Forward Current,<br>@ $T_A = 100^{\circ}C$<br>@ $T_A = 45^{\circ}C$ |        | 8.0<br>6.0  |     |     |     |     | A<br>A |       |
| I <sub>FSM</sub>   | Non-Repetitive Peak Forward Surge Current<br>8.3ms Single Half-Sine-Wave               | 200    |             |     | А   |     |     |        |       |
| T <sub>STG</sub>   | Storage Temperature Range -55 to +150  |        |             |     | °C  |     |     |        |       |
| Τ <sub>J</sub>     | Operating Junction Temperature   |        | -55 to +150 |     |     |     |     | °C     |       |

# Absolute Maximum Ratings \* $T_A = 25^{\circ}C$ unless otherwise noted

\* These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

# **Thermal Characteristics**

| Symbol                | Parameter  | Value | Units |  |
|-----------------------|--|-------|-------|--|
| PD                    | Power Dissipation                                  | 16    | W     |  |
| $R_{	extsf{	heta}JA}$ | Thermal Resistance, Junction to Ambient, * per leg | 18    | °C/W  |  |
| $R_{	extsf{	heta}JC}$ | Thermal Resistance, Junction to Case, * per leg    | 3     | °C/W  |  |

\* Device mounted on PCB with  $0.5 \times 0.5$ " (12 × 12mm).

# **Electrical Characteristics** $T_A = 25^{\circ}C$ unless otherwise noted

| Symbol         | Parameter  | Value      | Units            |  |  |
|----------------|--|------------|------------------|--|--|
| V <sub>F</sub> | Forward Voltage, per element @ 8.0A  | 1.0        | V                |  |  |
| I <sub>R</sub> | Reverse Current, per element @ Rated V <sub>R</sub><br>$T_A = 25^{\circ}C$<br>$T_A = 100^{\circ}C$ | 5.0<br>500 | μΑ<br>μΑ         |  |  |
|                | I <sup>2</sup> t Rating for Fusing t < 8.35ms  | 166        | A <sup>2</sup> s |  |  |

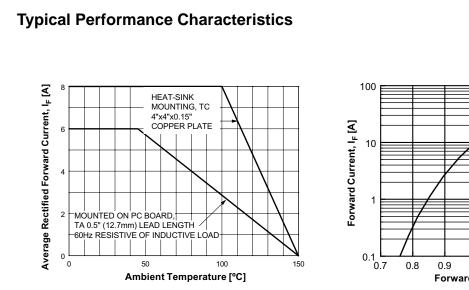


Figure 1. Forward Current Derating Curve

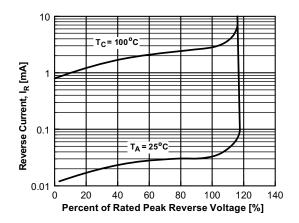


Figure 3. Reverse Current vs Reverse Voltage

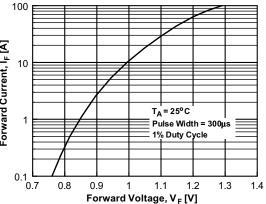


Figure 2. Forward Voltage Characteristics

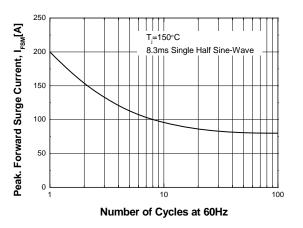


Figure 4. Non-Repetitive Surge Current

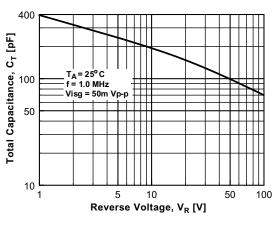


Figure 5. Total Capacitance

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